106年98月08月(株) 18時06分 %先: 早春詩3

完全:松下電器主黨 半導体開発本部 四點的守卫

무난되기요

9.02/04

Docket No.

Title: SIGNAL PROCESSING CIRCUIT

MEI Form -1.2, (July 1, 2005)

DECLARATION AND P	POWER OF ATT	ORNEY FOR	R U.S. P.	ATENT APPLICATION
& Original	☐ Supplemental	□ Substitute	D PCT	D Design

As a below named inventor, I hereby declare that; my residence, post office address and citizenship are as stated below next to my name; and I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural inventors are named below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

which is described and clai	imed in (if the following box is not checked, tion, or Application No	the specification of which is at	tached hereto):
in the specification in the	Application No.	filed on	<del></del> -1
and with amenoments	filed on	(if applicat	ole), or
G was specimental in military	ernancha Application No. PC-17 19700a/0	18145	
filed <u>December 6</u>	2004 and as amended on	(if applic	cable).
l acknowledge my	I have reviewed and understand the content ment(s) referred to above. duty to disclose to the U.S. Patent and Trac title 37, Code of Federal Regulations, §1.56.		
country other than the Unite	eign priority benefits under Title 35, United inventor's certificate, or §365(a) of any PC ed States of America, listed below, and have ny PCT international application having a fi	I international application wh	nich designated at least one
COUNTRY	APPLICATION NO.	DATE OF FILING	PRIORITY CLAIMED

COUNTRY	APPLICATION NO.	DATE OF FILING	PRIORITY CLAIMED
Japan	2003-413664	December 11, 2003	Yes

☐ Additional foreign or international application numbers are listed on a supplemental priority sheet attached hereto.

I hereby claim the benefit under Title 35, United States Code §119(e) of any United States Provisional application(s) listed below.

Number	(Day/Month/Year Filed)

□ Additional U.S. provisional application numbers are listed on a supplemental priority sheet attached hereto.

706年06月06日(水) 16時06分 宛先: 手瀬橋

発信:松下電器建築 半導体開発本部 知知時日

R:984

P. 03/04

Ket No. MEI Form -1.2, (July 1, 2005)

Docket No.

I hereby claim the benefit under Title 35, United States Code §120 of any United States application(s), or §365(C) of any PCT international application designating the United States of America, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT international application in the manner provided by the first paragraph of Title 35, United States Code §112, I acknowledge the duty to disclose information material to patentability as defined in Title 37, Code of Federal Regulations, §1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application.

APPLICATION NO.	U.S. FILING DATE	STATUS: PATENTED, PENDING, ABANDONED

n Additional U.S. or international application numbers are listed on a supplemental priority sheet attached hereto.

POWER OF ATTORNEY: As a named inventor, I hereby appoint the attorneys and agents associated with U.S. Patent and Trademark Office Customer Number identified bellow to prosecute this application and to transact all business in the U.S. Patent and Trademark Office connected therewith, and direct that all correspondence be addressed to that customer number.

I hereby authorize the U.S. attorneys and agents associated with the customer number to accept and follow instructions from Matsushita Electric Industrial Co., Ltd., and any affiliated or subsidiary company thereof, received via their corporate representatives and/or their foreign patent attorneys or agents, if any, as to any action to be taken in the U.S. Patent and Trademark Office regarding this application without direct communication between the U.S. attorneys or agents and myself.

Direct Correspondence to:

CUSTOMER NUMBER 53080

I further declare that all statements made herein of my own knowledge are true, and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Full Name of Sole or First Inventor	FIRST NAME Yasuo	LAST NAME NAKATA	SIGNATURE Yarvo Trakata	DATE OF	SIGNATURE
Residence & Citizenship	CITY Osaka	STATE OR COUN Japan	TRY	COUNTRY OF	
Post Office Address	ADDRESS c/o Matsushita Ele	CITY ctric Industrial Co., Ltd.	STATE OR	COUNTRY	ZIP CODE
	1006, Oaza Kadon	na, Kadoma-shi, Osaka	571-8501 Japan		

Full Name of Second Inventor	FIRST NAME	LAST NAME	SIGNATURE	DATE O	F SIGNATURE
	Naoyuki	KASHII	naoguku Kushii	May 31	. 2006
Residence & Citizenship	CITY	STATE OR COUNT	TRY	COUNTRY OF	CITIZENSHIP
	Osaka	Japan			pan
Post Office Address	ADDRESS c/o Matsushita Ele	CITY ctric Industrial Co., Ltd.	STATE OF	RCOUNTRY	ZIP CODE
	1006, Oaza Kador	па, Kadoma-shi, Osaka S	71-8501 Japan		

106年06月085 (火) 16時06分 港: 早齢2

発信:松下電器產業 半導体開発本部 知期部守口

R:984

2.04/04

Docket No.

MEI Form -1.2, (July 1, 2005)

Full Name of Third Inventor	FIRST NAME	LAST NAME	SIGNATURE	DATE	F SIGNATUR
Residence & Citizenship	CITY	STATE OR COUNTRY	1	COUNTRY	F CITIZENSH
Post Office Address	ADDRESS	CITY	STATE	OR COUNTRY	ZIP CO
Full Name of	FIRST NAME	LAST NAME	SIGNATURE	DATE	F SIGNATUR
Residence & Citizenship	CITY	STATE OR COUNTRY			
Post Office Address			COUNTRY OF CITIZE		FCITIZENSH
on office Address	ADDRESS	СПҮ	STATE OR COUNTRY		ZIP COL
ull Name of lifth Inventor	FIRST NAME	LAST NAME	SIGNATURE	DATE O	F SIGNATUR
Residence & Citizenship	CITY	STATE OR COUNTRY	Y COUNTRY OF CITIZE		CITIZENSHI
Post Office Address	ADDRESS	CITY	STATE C	OR COUNTRY	ZIP COD
full Name of	FIRST NAME	LAST NAME	SIGNATURE	2475	
sixth Inventor			OIONA, ORC	UATEOF	SIGNATURE
Residence & Clt/zenship	CITY	STATE OR COUNTRY		COUNTRY OF	CITIZENSHII
Post Office Address	ADDRESS	CITY	STATE O	R COUNTRY	ZIP CODI
ull Name of	FIRST NAME	LAST NAME			
eventh inventor		CASTINAME	SIGNATURE DATE OF SIGNATURE		SIGNATURE
lesidence & Citizenship	CITY	STATE OR COUNTRY		COUNTRY OF	CITIZENSHIP
ost Office Address	ADDRESS	СІТҮ	STATE O	RCOUNTRY	ZIP CODE
(If there are more that inventors) above application may be m		add a copy of this page for idea	ntification and signat	we for the wklitio	បធា
		Filing Date			